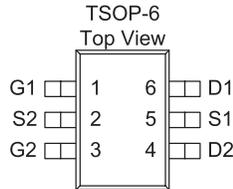


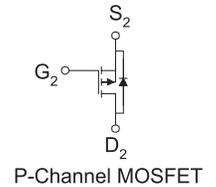
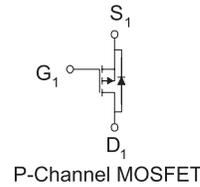
P-Channel 30-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize High Cell Density process. Low $r_{DS(on)}$ assures minimal power loss and conserves energy, making this device ideal for use in power management circuitry. Typical applications are DC-DC converters, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low $r_{DS(on)}$ Provides Higher Efficiency and Extends Battery Life
- Miniature TSOP-6 Surface Mount Package Saves Board Space



PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (OHM)	I_D (A)
-30	0.130 @ $V_{GS} = -10V$	-2.5
	0.190 @ $V_{GS} = -4.5V$	-1.9



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ^a	I_D	$T_A = 25^\circ C$	-2.5
		$T_A = 70^\circ C$	-1.9
Pulsed Drain Current ^b	I_{DM}	-10	A
Continuous Source Current (Diode Conduction) ^a	I_S	± 1.6	A
Power Dissipation ^a	P_D	$T_A = 25^\circ C$	1.15
		$T_A = 70^\circ C$	0.7
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ C$

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typ	Max	
Maximum Junction-to-Ambient ^a	R_{thJA}	t \leq 10 sec	93	110
		Steady State	130	150
				$^\circ C/W$

Notes

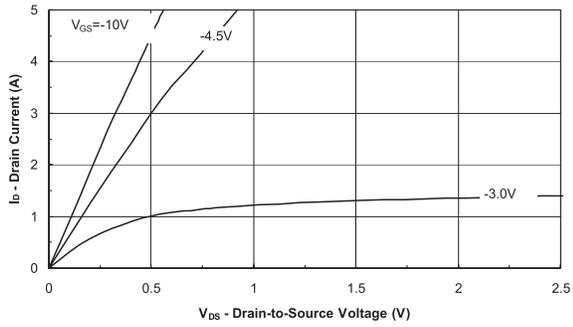
- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ	Max	
Static						
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-1.00			
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$			-1	uA
		$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			-10	
On-State Drain Current ^A	$I_{D(on)}$	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	-3			A
Drain-Source On-Resistance ^A	$r_{DS(on)}$	$V_{GS} = -10 \text{ V}, I_D = -2.5 \text{ A}$			0.130	Ω
		$V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$			0.190	
Forward Transconductance ^A	g_s	$V_{DS} = -5 \text{ V}, I_D = -2.5 \text{ A}$		3		S
Diode Forward Voltage	V_{SD}	$I_S = -1.6 \text{ A}, V_{GS} = 0 \text{ V}$		-0.70		V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V},$ $I_D = -2.5 \text{ A}$		6.0		nC
Gate-Source Charge	Q_{gs}			0.80		
Gate-Drain Charge	Q_{gd}			1.30		
Input Capacitance	C_{iss}	P-Channel $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		451		pF
Output Capacitance	C_{oss}			130		
Reverse Transfer Capacitance	C_{rss}			33		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -5 \text{ V}, R_L = 5 \text{ OHM},$ $V_{GEN} = -4.5 \text{ V}, R_G = 6 \text{ OHM}$		6.5		ns
Rise Time	t_r			20		
Turn-Off Delay Time	$t_{d(off)}$			31		
Fall-Time	t_f			21		

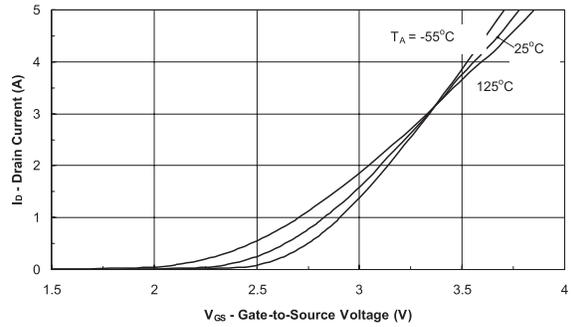
Notes

- Pulse test: $PW \leq 300 \mu\text{s}$ duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.

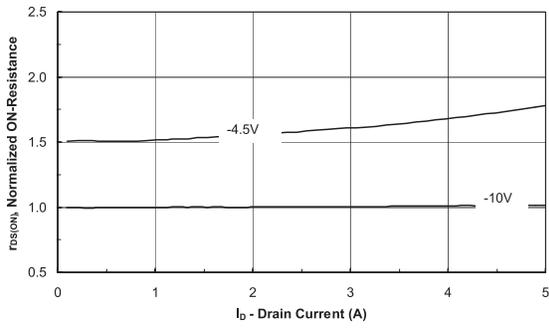
Typical Electrical Characteristics (P-Channel)



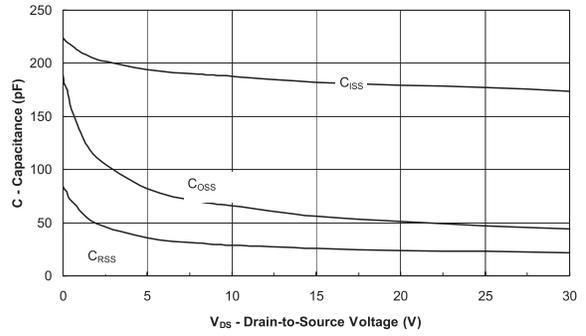
Output Characteristics



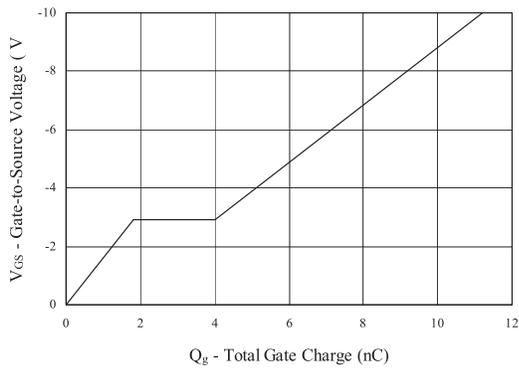
Transfer Characteristics



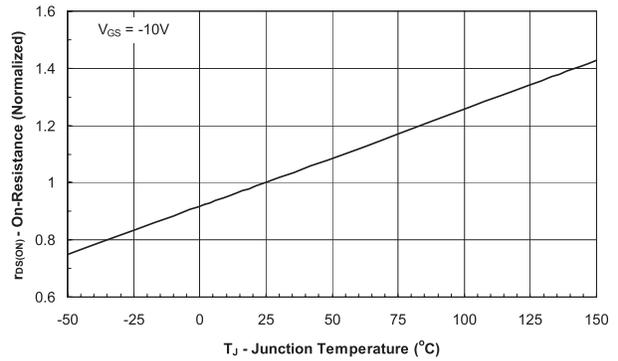
On-Resistance vs. Drain Current



Capacitance

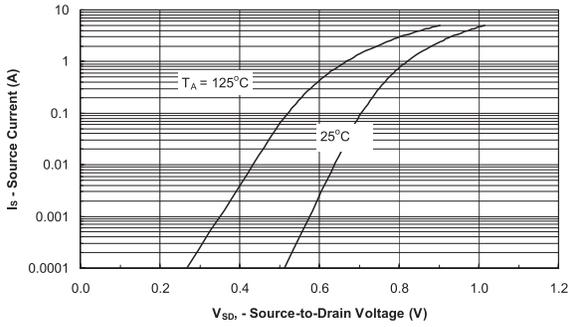


Gate Charge

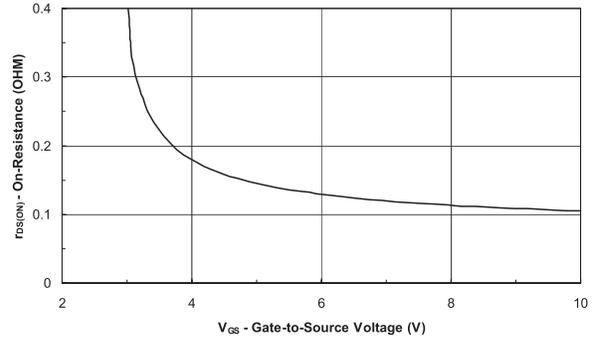
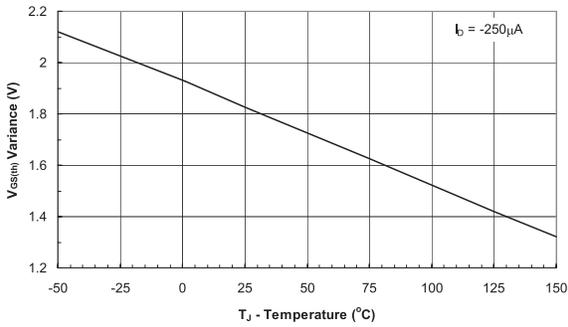


On-Resistance vs. Junction Temperature

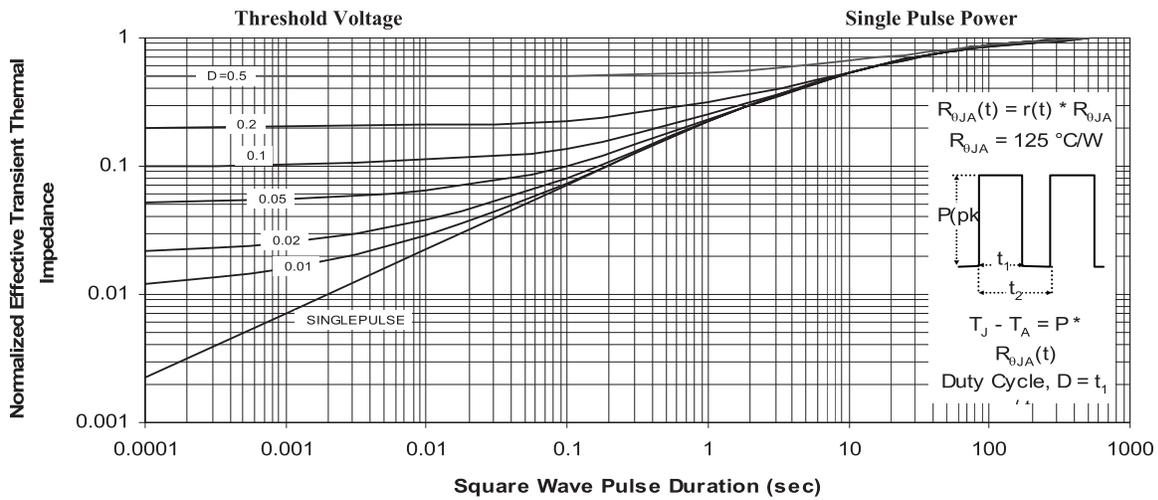
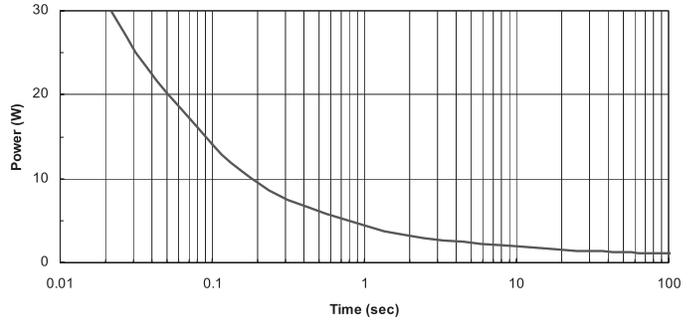
Typical Electrical Characteristics (P-Channel)



Source-Drain Diode Forward Voltage



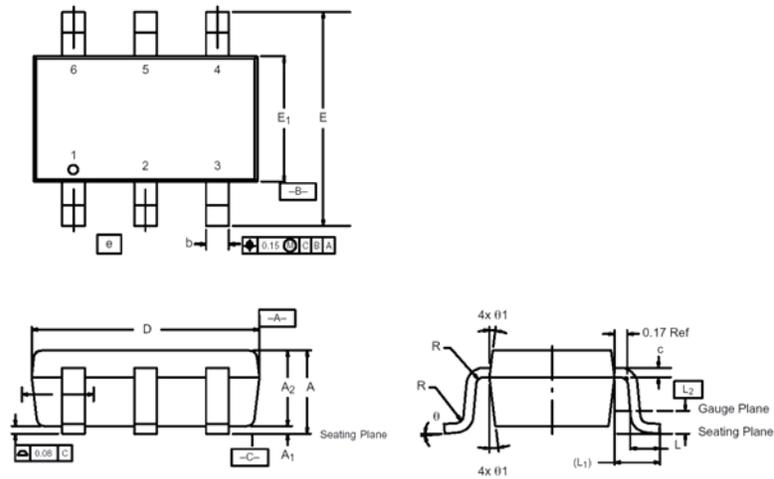
On-Resistance vs. Gate-to Source Voltage



Normalized Thermal Transient Impedance, Junction-to-Ambient

Package Information

TSOP-6: 6LEAD



Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.91	–	1.10	0.036	–	0.043
A₁	0.01	–	0.10	0.0004	–	0.004
A₂	0.84	–	1.00	0.033	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E₁	1.55	1.65	1.70	0.061	0.065	0.067
e	1.00 BSC			0.0394 BSC		
L	0.35	–	0.50	0.014	–	0.020
L₁	0.60 Ref			0.024 Ref		
L₂	0.25 BSC			0.010 BSC		
R	0.10	–	–	0.004	–	–
θ	0°	4°	8°	0°	4°	8°
θ₁	7° Nom			7° Nom		